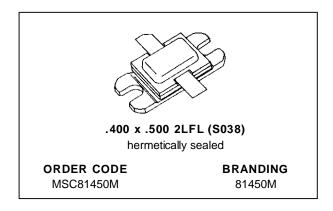


MSC81450M

RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

- REFRACTORY\GOLD METALLIZATION
- RUGGEDIZED VSWR 25:1
- INTERNAL INPUT/OUTPUT MATCHING
- LOW THERMAL RESISTANCE
- METAL/CERAMIC HERMETIC PACKAGE
- P_{OUT} = 450 W MIN. WITH 7.0 dB GAIN

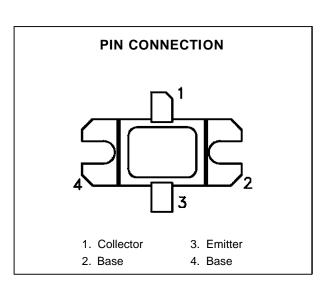


DESCRIPTION

The MSC81450M device is a high power pulsed transistor specifically designed for IFF avionics applications.

This device is capable of withstanding a minimum 25:1 load mismatch at any phase angle under full rated conditions.

The MSC81450M is housed in the unique BIG-PACTM package with internal input/output matching structures.



ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

,					
Symbol	Parameter	Value	Unit		
P _{DISS}	Power Dissipation*	910	W		
Ic	Device Current*	28	А		
Vcc	Collector-Supply Voltage*	55	V		
TJ	Junction Temperature (Pulsed RF Operation)	250	°C		
T _{STG}	Storage Temperature	- 65 to +200	°C		

THERMAL DATA

R _{TH(j-c)} J	Junction-Case Thermal Resistance*	0.15	°C/W
------------------------	-----------------------------------	------	------

^{*}Applies only to rated RF amplifier operation

ELECTRICAL SPECIFICATIONS $(T_{case} = 25^{\circ}C)$

STATIC

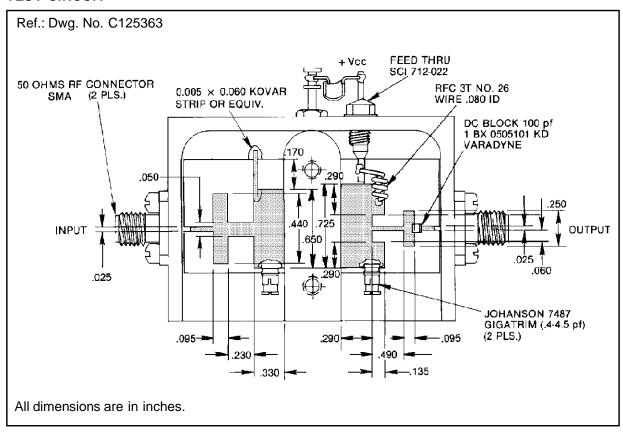
Symbol	Test Conditions	Value			Unit		
	rest Conditions		Min.	Тур.	Max.	Oiiit	
BV _{CBO}	$I_C = 15mA$	$I_E = 0mA$		65	_		V
BV _{EBO}	I _E = 1mA	$I_C = 0mA$		3.5	_		V
BV _{CER}	$I_C = 50mA$	$R_{BE} = 10\Omega$		65	_		V
Ices	V _{CE} = 50V			_	_	35	mA
hFE	V _{CE} = 5V	$I_C = 1A$		15	_	120	_

DYNAMIC

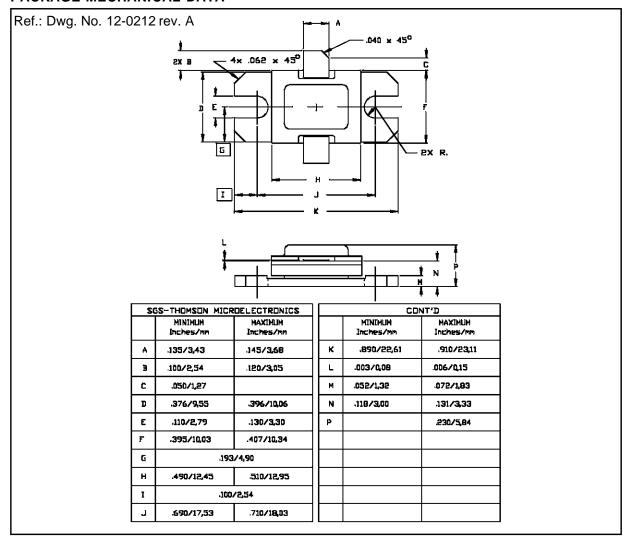
Symbol	Test Conditions				Value		Unit
Symbol				Min.	Тур.	Max.	Unit
Pout	f = 1090 MHz	$P_{IN} = 90 W$	$V_{CC} = 50 \text{ V}$	450	500	_	W
ης	f = 1090 MHz	$P_{IN} = 90 \text{ W}$	$V_{CC} = 50 \text{ V}$	40	_	_	%
GP	f = 1090 MHz	P _{IN} = 90 W	$V_{CC} = 50 \text{ V}$	7.0	_	_	dB

Note: Pulse Width = $10\mu Sec$ Duty Cycle = 1%

TEST CIRCUIT



PACKAGE MECHANICAL DATA



Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.